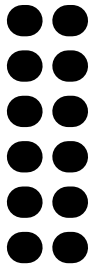
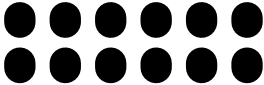
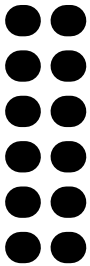
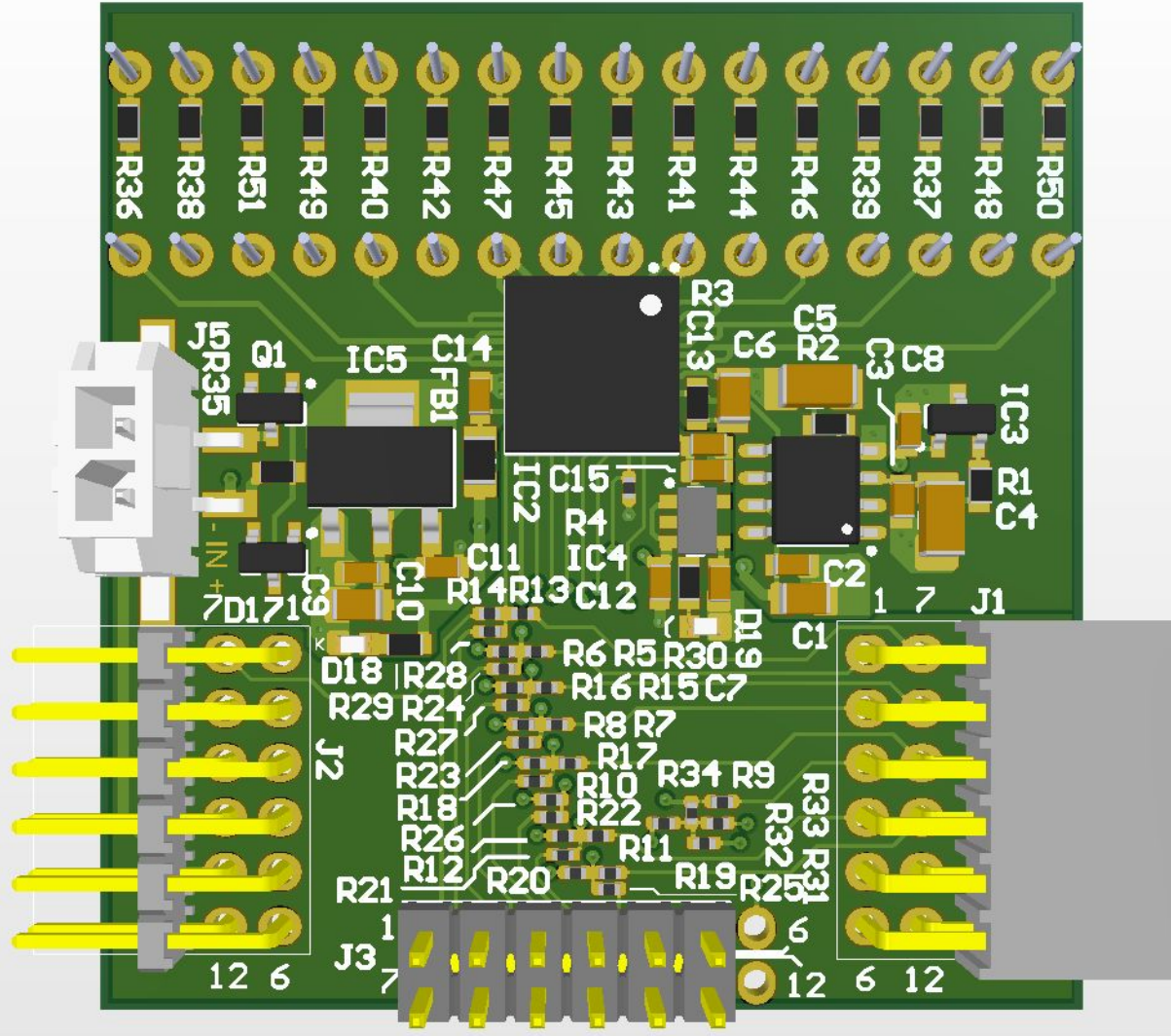
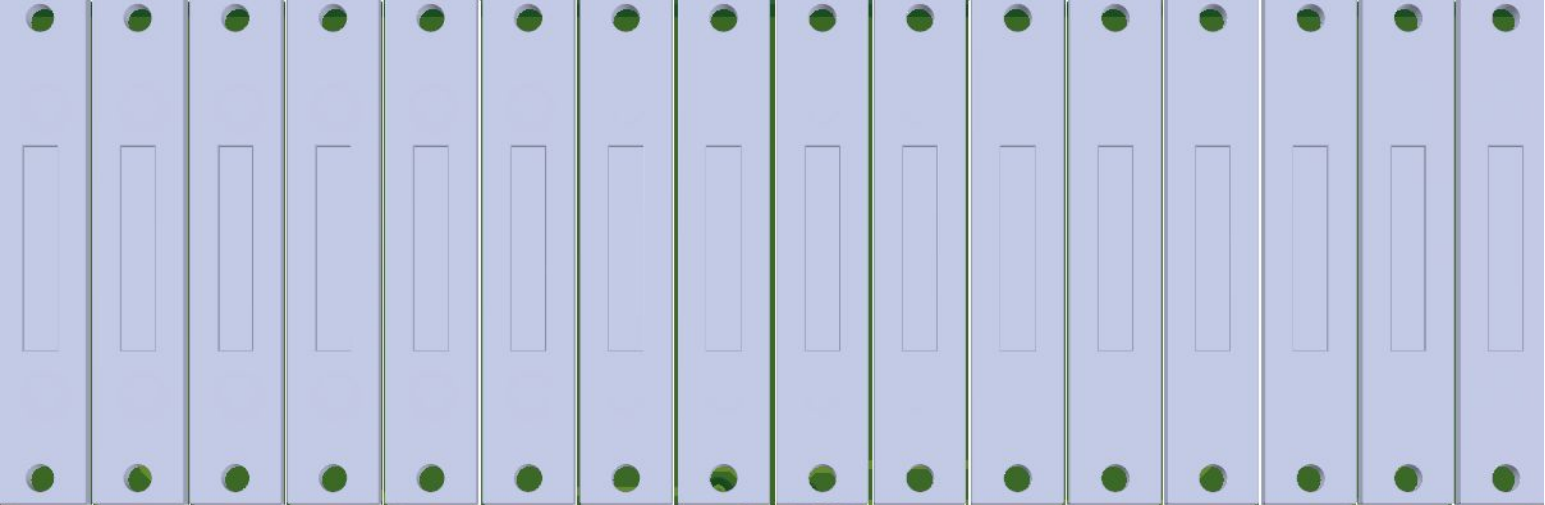


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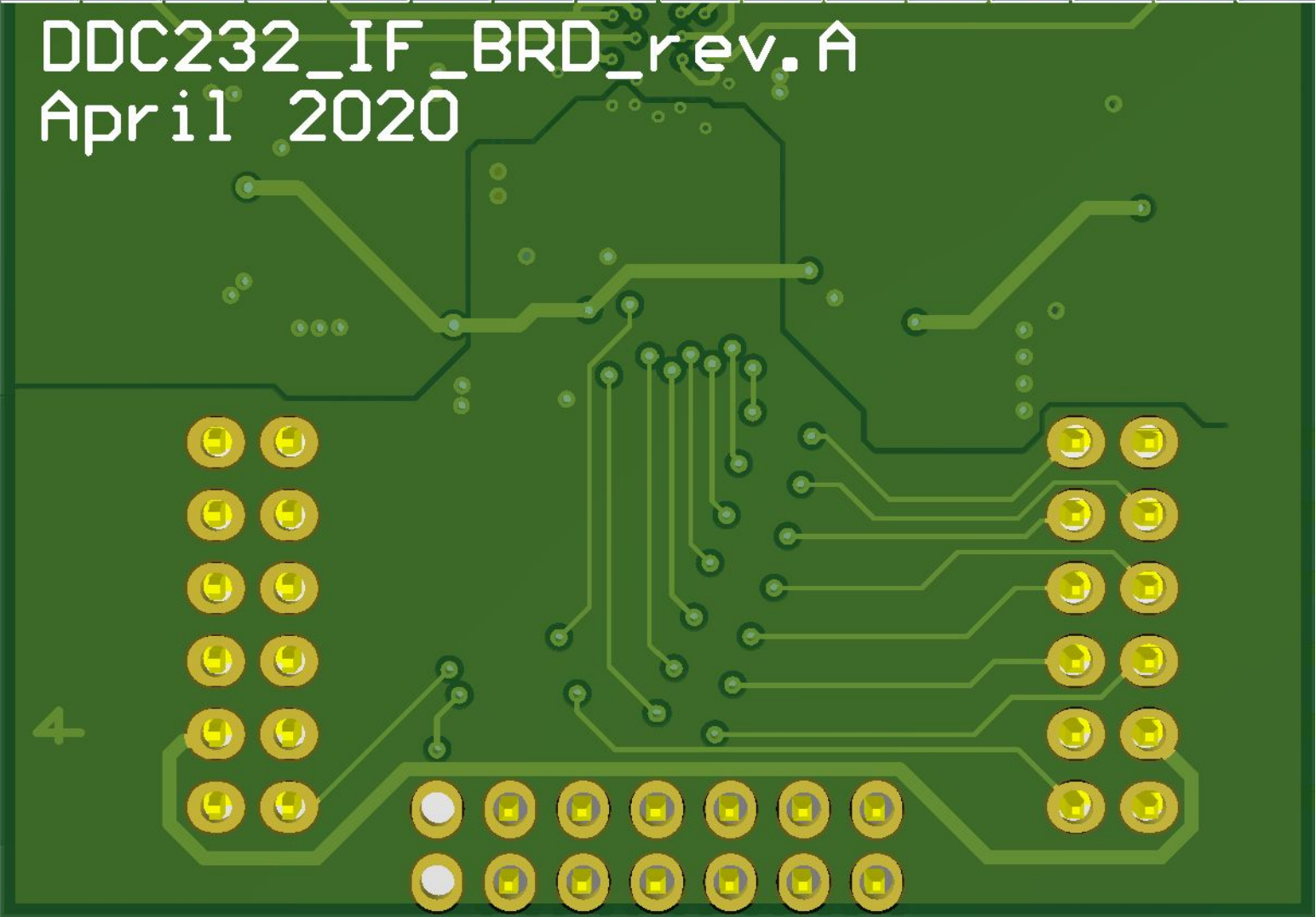


Bottom Overlay





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Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0,010mm	3,5	
1	Top Layer 1	Copper	0,036mm		
	Dielectric 2	PP-006	0,100mm	4,1	
2	Layer 2	Copper	0,035mm		
	Dielectric 1	FR-4	1,200mm	4,8	
3	Layer 3	Copper	0,035mm		
	Dielectric 3	PP-006	0,100mm	4,1	
4	Bottom Layer 4	Copper	0,036mm		
	Bottom Solder	Solder Resist	0,010mm	3,5	
	Bottom Overlay				

